TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# **TC7W241FU**

#### Non-Inverted, 3-State Outputs

The TC7W241FU is a high speed  $C^2MOS$  Dual Bus Buffers fabricated with silicon gate  $C^2MOS$  technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the C<sup>2</sup>MOS low power dissipation.

It is a non-inverting 3-state buffer has one active-high and one active-low output enable.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

# SSOP8-P-0.65

Weight: 0.02 g (typ.)

#### **Features**

- High speed:  $t_{pd} = 10 \text{ ns (typ.)}$  at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 2 \mu A \text{ (max)}$  at  $T_{a} = 25 \text{°C}$
- High noise immunity: VNIH = VNIL = 28% VCC (min)
- Output drive capability: 15 LSTTL loads
- Symmetrical output impedance: | I<sub>OH</sub> | = I<sub>OL</sub> = 6 mA (min)
- Balanced propagation delays:  $t_pLH \simeq t_pHL$
- Wide operating voltage range: VCC (opr) = 2 to 6 V

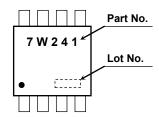
#### **Absolute Maximum Ratings (Ta = 25°C)**

Characteristics	Symbol	Rating	Unit	
Supply voltage range	V <sub>CC</sub>	–0.5 to 7	٧	
DC input voltage	V <sub>IN</sub>	$-0.5$ to $V_{CC} + 0.5$	٧	
DC output voltage	V <sub>OUT</sub>	$-0.5$ to $V_{CC} + 0.5$	V	
Input diode current	I <sub>IK</sub>	±20	mA	
Output diode current	I <sub>OK</sub>	±20	mA	
DC output current	I <sub>OUT</sub>	±35	mA	
DC V <sub>CC</sub> /ground current	Icc	±37.5	mA	
Power dissipation	P <sub>D</sub>	300	mW	
Storage temperature range	T <sub>stg</sub>	-65 to 150	°C	
Lead temperature (10 s)	TL	260	°C	

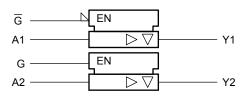
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

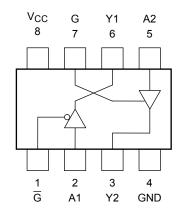
# Marking



### **Logic Diagram**



# Pin Configuration (top view)



#### **Truth Table**

	Output		
G	G	Α	Y
L	Н	L	L
L	Н	Н	Н
Н	L	Х	Z

X: Don't care

Z: High impedance

# **Operating Ranges**

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	2 to 6	V
Input voltage	V <sub>IN</sub>	0 to V <sub>CC</sub>	V
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	٧
Operating temperature range	T <sub>opr</sub>	-40 to 85	°C
		0 to 1000 (V <sub>CC</sub> = 2.0 V)	
Input rise and fall time	t <sub>r</sub> , t <sub>f</sub>	0 to 500 (V <sub>CC</sub> = 4.5 V)	ns
		0 to 400 (V <sub>CC</sub> = 6.0 V)	

# **Electrical Characteristics**

#### **DC Electrical Characteristics**

Characteristics Syn		Symbol	Symbol Test Condition			Ta = 25°C			Ta = -40 to 85°C		Unit
					V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	0
		V <sub>IH</sub>	_		2.0	1.5	_	_	1.5	_	
	High level				4.5	3.15	_	_	3.15	_	
Input voltage					6.0	4.2	_	_	4.2	_	V
Input voltage			_		2.0	_	_	0.5	_	0.5	v
	Low level	VIL			4.5	_	_	1.35	_	1.35	
					6.0	_	_	1.8	_	1.8	
			V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -20 μA	2.0	1.9	2.0	_	1.9	_	V
	High level	Vон			4.5	4.4	4.5	_	4.4	_	
					6.0	5.9	6.0	_	5.9	_	
				$I_{OH} = -6 \text{ mA}$	4.5	4.18	4.31	_	4.13	_	
Output				$I_{OH} = -7.8 \text{ mA}$	6.0	5.68	5.80	_	5.63	_	
voltage	Low level	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	Ι <sub>ΟL</sub> = 20 μΑ	2.0	_	0	0.1	_	0.1	
					4.5	_	0	0.1	_	0.1	
					6.0	_	0	0.1	_	0.1	
				$I_{OL} = 6 \text{ mA}$	4.5	_	0.17	0.26	_	0.33	
				$I_{OL} = 7.8 \text{ mA}$	6.0		0.18	0.26	_	0.33	
3-state output off-state current		l <sub>OZ</sub>	$V_{IN} = V_{IH}$ or $V_{IL}$ $V_{OUT} = V_{CC}$ or GND		6.0	_	_	±0.5	_	±5.0	μА
Input leakage of	Input leakage current $I_{IN}$ $V_{IN} = V_{CC}$ or GND		r GND	6.0	_	_	±0.1	_	±1.0	μА	
Quiescent supply current $I_{CC}$ $V_{IN} = V_{CC}$ or GND		r GND	6.0	_	_	2.0	_	20.0	μА		



# AC Electrical Characteristics (input $t_r = t_f = 6 \text{ ns}$ )

Characteristics	Symbol	Test Condition			Ta = 25°C			Ta = -40 to 85°C		Unit
		Tool container	C <sub>L(pF)</sub>	V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	01111
Output transition time	t <sub>TLH</sub>	_	50	2.0	_	25	60	_	75	ns
				4.5	_	7	12	_	15	
	TITLE			6.0		6	10	_	13	
				2.0		36	90	_	115	
			50	4.5	_	12	18	_	23	ns
Propagation delay time	t <sub>pLH</sub>			6.0	_	10	15	_	20	
Tropagation delay time	t <sub>pHL</sub>	_		2.0	_	51	130	_	165	
			150	4.5	_	17	26	_	33	ns
				6.0	_	14	22	_	28	
	t <sub>pZL</sub> t <sub>pZH</sub>	$R_L = 1 \text{ k}\Omega$		2.0	_	48	125	_	155	ns
			50	4.5	_	16	25	_	31	
Output enable time				6.0	_	14	21	_	26	
Output enable time			150	2.0	_	63	165	_	205	
				4.5	_	21	33	_	41	
				6.0	_	18	28	_	35	
	t <sub>pLZ</sub> t <sub>pHZ</sub>	$R_L = 1 \text{ k}\Omega$	50	2.0	_	32	125	_	155	ns
Output disable time				4.5	_	15	25	_	31	
				6.0	_	14	21	_	26	
Input capacitance	C <sub>IN</sub>	_	_	_	_	5	10	_	10	pF
Output capacitance	C <sub>OUT</sub>	_		_	_	10	_	_	_	pF
Power dissipation capacitance	C <sub>PD</sub>	(Note)	_	_	_	33	_	_	_	pF

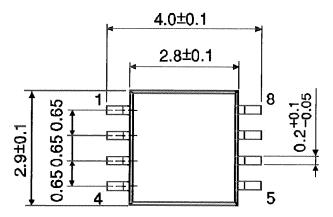
Note: C<sub>PD</sub> is defined as the value of internal equivalent capacitance which is calculated from the operating current consumption without load.

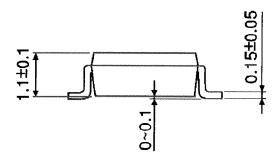
Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/2 \text{ (per gate)}$ 

# **Package Dimensions**

SSOP8-P-0.65 Unit: mm





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Weight: 0.02 g (typ.)

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